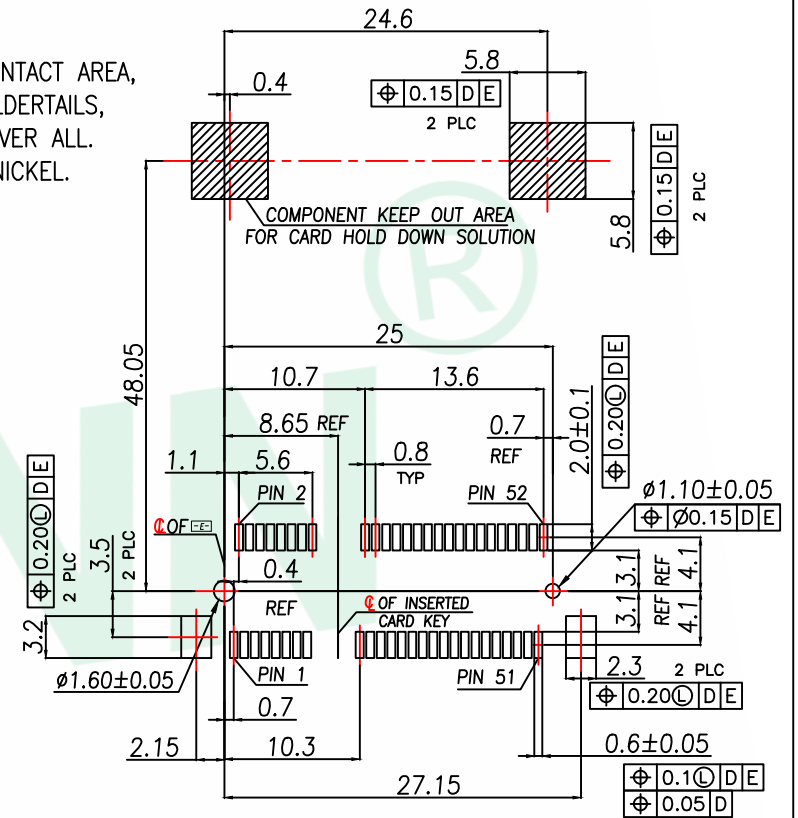
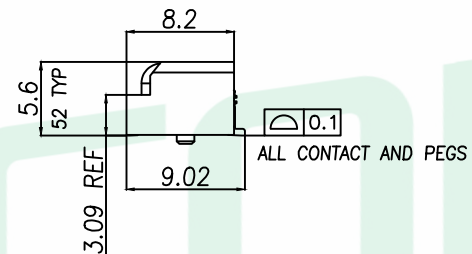
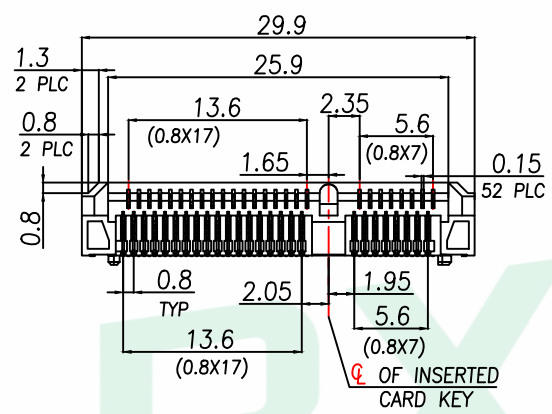
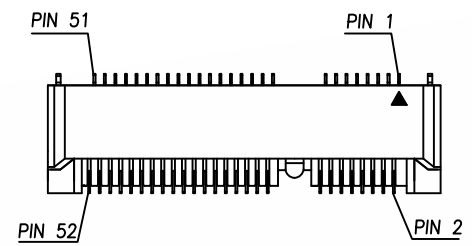


REV.	DESCRIPTION	ECN NO.	NAME	DATE

NOTES:

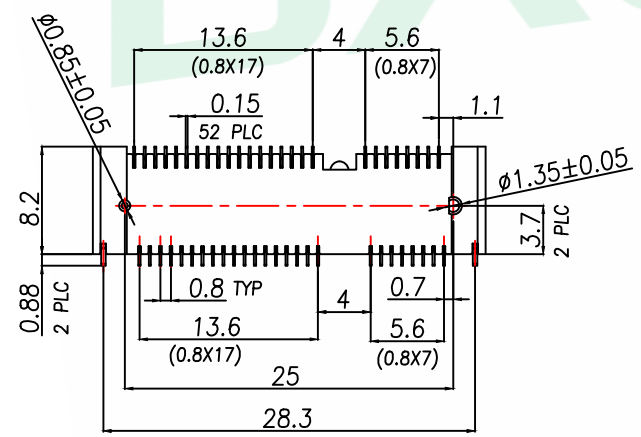
- MATERIAL:  
HOUSING: THERMOPLASTIC, HIGH TEMP, UL94V-0, BLACK COLOR,  
CONTACTS: COPPER ALLOY.  
PEGS: COPPER ALLOY.
- FINISH:  
CONTACTS: SELECTED GOLD PLATING ON THE CONTACT AREA,  
1u" MIN. GOLD PLATING ON THE SOLDERTAILS,  
50 u" MIN. NICKEL UNDERPLATING OVER ALL.  
PEGS: 120u" MIN. MATTE-TIN OVER 50u" MIN. NICKEL.



SPECIFICATION

CURRENT RATING : 0.5A 50V AC/DC  
CONTACT RESISTANCE : 55 mΩ MAX  
INSULATION RESISTANCE : 500 MΩ MIN AT 500V DC  
OPERATING TEMPERATURE : -55°C~80°C

-D- IS THE TOP SURFACE OF PCB.  
RECOMMENDED P.C.BOARD PATTERN LAYOUT



GENERAL TOLERANCE		DONGGUAN BAOXUN PRECISION TECHNOLOGY CO., LTD		
DIM.	TOL.	TITLE: 0.80MM PITCH MINPCIEXPRESS HIGH=5.6mm 52 PIN CONNECTOR		
x.	±0.30	DWG. NO.: PCIE-H5.6-P5236	CHECKED: MAX	
x.x	±0.25	PART NO.: PCIE-H5.6-P5236	DRAWN: ELLA	
x.xx	±0.15	UNIT: mm	SCALE: none	
GENERAL ANGLE:	±5.0°	SHEET: 1 of 1	DWG. SIZE: A4	
x.	±1.0°	LAYER: bxconn	APPROVED: WILL	
x.x'	±1.0°			
x.xx'	±1.0°			